

Original document

DELIVERY METHOD USING DELIVERY SLIP WITH REUSABLE IC TAG

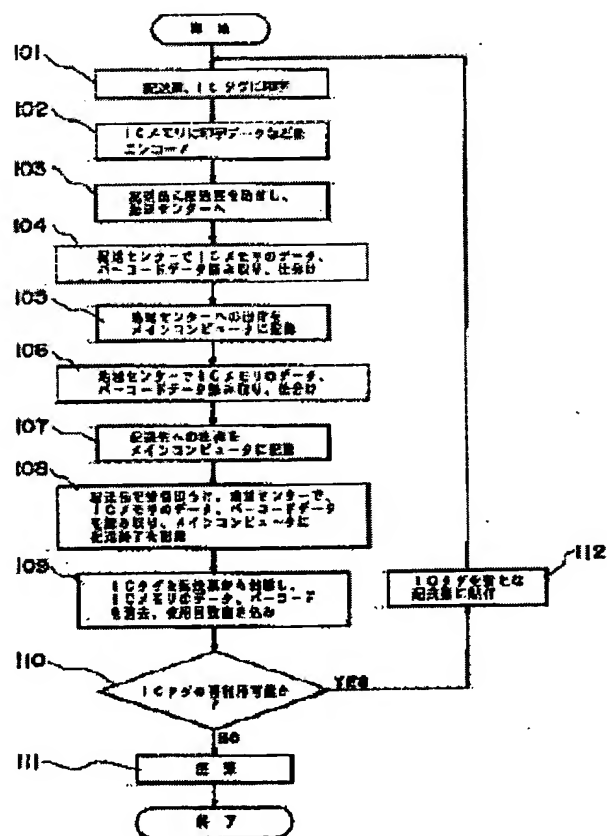
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Abstract of JP2002211755

PROBLEM TO BE SOLVED: To provide a delivery method using a delivery slip with an IC tag capable of contributing to enhancing efficiency of deliver work by using the IC tag, allowing printing by a printer with the IC tag attached and providing reusing of the IC tag.

SOLUTION: Delivery information is printed in a delivery information writing space of the delivery slip and a rewrite layer of the IC tag, and at the same time or before or after the printing, delivery information including at least the printed delivery information is written in a memory of a non-contact IC chip provided on the IC tag. The delivery work is performed on the basis of the written delivery information. After finishing the delivery work, the IC tag is separated from the delivery slip, the information printed in the rewrite layer and the information written in the memory of the IC chip are erased, and the IC tag is separably provided on a new delivery slip and used in delivery work.



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